

**FEATURES**

- Double Side Cooling
- High Surge Capability

**APPLICATIONS**

- Crowbar
- High Power Drives
- High Voltage Power Supplies
- Static Switches

**VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages $V_{DRM}$ and $V_{RRM}$ (V)	Conditions
DCR3620M65*	6500	$T_{vj} = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$ , $I_{DRM} = I_{RRM} = 300\text{mA}$ , $V_{DRM}, V_{RRM} t_p = 10\text{ms}$ $V_{DSM} \& V_{RSM} =$ $V_{DRM} \& V_{RRM} + 100\text{V}$ respectively
DCR3620M60	6000	
DCR3620M55	5500	

Lower voltage grades available.

\*6200V @  $-40^{\circ}\text{C}$ , 6500V @  $0^{\circ}\text{C}$

**KEY PARAMETERS**

$V_{DRM}$	<b>6500V</b>
$I_{T(AV)}$	<b>3620A</b>
$I_{TSM}$	<b>44700A</b>
$dV/dt^*$	<b>2000V/<math>\mu\text{s}</math></b>
$dI/dt$	<b>500A/<math>\mu\text{s}</math></b>

\* Higher  $dV/dt$  selections are available on request

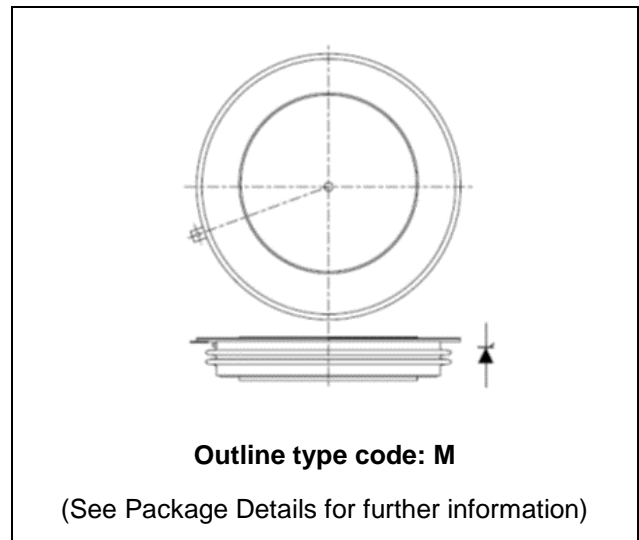


Fig. 1 Package outline

**ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

**DCR3620M65**

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

## CURRENT RATINGS

$T_{case} = 60^{\circ}C$  unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
<b>Double Side Cooled</b>				
$I_{T(AV)}$	Mean on-state current	Half wave resistive load	3620	A
$I_{T(RMS)}$	RMS value	-	5690	A
$I_r$	Continuous (direct) on-state current	-	5320	A

## SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
$I_{TSM}$	Surge (non-repetitive) on-state current	10ms half sine, $T_{case} = 125^{\circ}C$ $V_R = 0$	44.7	kA
$I^2t$	$I^2t$ for fusing		9.99	MA <sup>2</sup> s

## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	Min.	Max.	Units	
$R_{th(j-c)}$	Thermal resistance - junction to case	Double side cooled	DC	-	5.2	$^{\circ}C/kW$
		Single side cooled	Anode DC	-	10.1	$^{\circ}C/kW$
			Cathode DC	-	10.8	$^{\circ}C/kW$
$R_{th(c-h)}$	Thermal resistance - case to heatsink	Clamping force 83kN (with mounting compound)	Double side	-	1.0	$^{\circ}C/kW$
			Single side	-	2.0	$^{\circ}C/kW$
$T_{vj}$	Virtual junction temperature	Blocking $V_{DRM} / V_{RRM}$	-	125	$^{\circ}C$	
$T_{stg}$	Storage temperature range		-55	125	$^{\circ}C$	
$F_m$	Clamping force		74	91	kN	

**DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Typ.	Max.	Units
<b>I<sub>RRM</sub>/I<sub>DRM</sub></b>	Peak reverse and off-state current	At $V_{RRM}/V_{DRM}$ , $T_{case} = 125^{\circ}C$	-	300	mA
		At 50% $V_{RRM}/V_{DRM}$ , $T_{case} = 125^{\circ}C$	20	-	mA

Symbol	Parameter	Test Conditions	Min.	Max.	Units	
<b>V<sub>TM</sub></b>	Instantaneous forward voltage	At 4000A peak, $T_j = 125^{\circ}C$	1.80	2.05	V	
<b>dV/dt</b>	Max. linear rate of rise of off-state voltage	To 67% $V_{DRM}$ , $T_j = 125^{\circ}C$ , gate open	-	2000	V/ $\mu$ s	
<b>dI/dt</b>	Rate of rise of on-state current	From 67% $V_{DRM}$ to $2x I_{T(AV)}$ Gate source 30V, 10 $\Omega$ $t_r < 0.5\mu$ s, $T_j = 125^{\circ}C$	Repetitive 50Hz	-	200	A/ $\mu$ s
			Non-repetitive	-	500	A/ $\mu$ s
<b>V<sub>T(ro)</sub></b>	Threshold voltage - Low level	500A to 3300A at $T_{case} = 125^{\circ}C$	-	0.93	V	
	Threshold voltage - High level	3300A to 9000A at $T_{case} = 125^{\circ}C$	-	1.16	V	
<b>r<sub>T</sub></b>	On-state slope resistance - Low level	500A to 3300A at $T_{case} = 125^{\circ}C$	-	0.29	m $\Omega$	
	On-state slope resistance - High level	3300A to 9000A at $T_{case} = 125^{\circ}C$	-	0.22	m $\Omega$	
<b>t<sub>gd</sub></b>	Delay time	$V_D = 67\% V_{DRM}$ , gate source 30V, 10 $\Omega$ $t_r = 0.5\mu$ s, $T_j = 25^{\circ}C$	-	3	$\mu$ s	
<b>t<sub>q</sub></b>	Turn-off time	$I_T = 3000A$ , $T_j = 125^{\circ}C$ , $V_R = 200V$ , $dI/dt = 1A/\mu$ s, $dV_{DR}/dt = 20V/\mu$ s linear	-	500	$\mu$ s	
<b>Q<sub>s</sub></b>	Stored charge	$I_T = 1500A$ , $T_j = 125^{\circ}C$ , $dI/dt = 1A/\mu$ s	4540	8620	$\mu$ C	
<b>I<sub>RR</sub></b>	Reverse recovery current	$V_R \sim 2600V$ , $C_s = 1\mu$ F, $R_s = 63\Omega$	56	80	A	
<b>I<sub>L</sub></b>	Latching current	$T_j = 25^{\circ}C$ , $V_D = 5V$	-	3	A	
<b>I<sub>H</sub></b>	Holding current	$T_j = 25^{\circ}C$ , $R_{G-K} = \infty$ , $I_{TM} = 500A$ , $I_T = 5A$	-	300	mA	

## GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
$V_{GT}$	Gate trigger voltage	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	1.5	V
$V_{GD}$	Gate non-trigger voltage	At 50% $V_{DRM}, T_{case} = 125^{\circ}C$	0.4	V
$I_{GT}$	Gate trigger current	$V_{DRM} = 5V, T_{case} = 25^{\circ}C$	400	mA
$I_{GD}$	Gate non-trigger current	At 50% $V_{DRM}, T_{case} = 125^{\circ}C$	10	mA

## CURVES

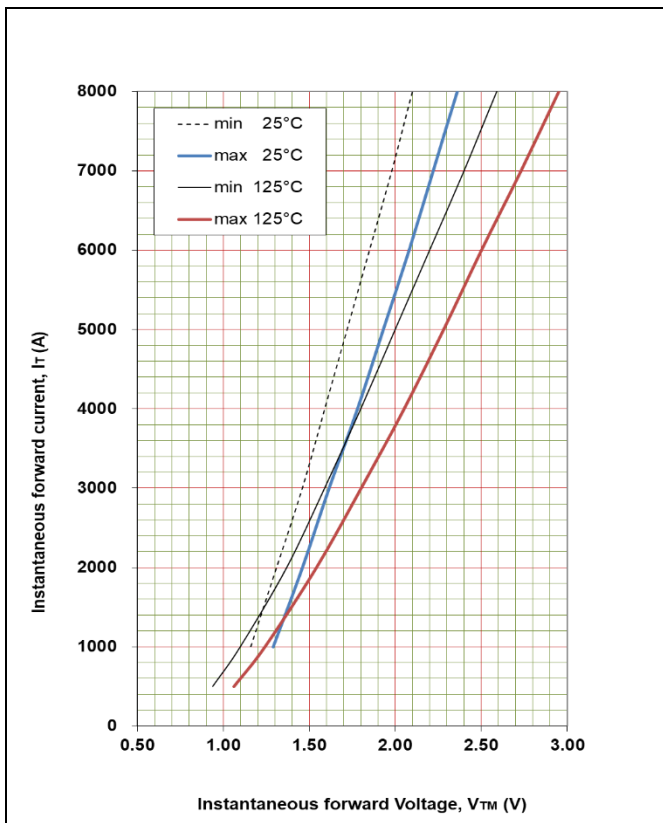


Fig. 2 Maximum & minimum on-state characteristics

## $V_{TM}$ EQUATION

$$V_{TM} = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

Where  $A = -0.632454$

$B = 0.283028$

$C = 0.000246$

$D = -0.010394$

These values are valid for  $T_j = 125^{\circ}C$  for  $I_T$  500A to 9000A

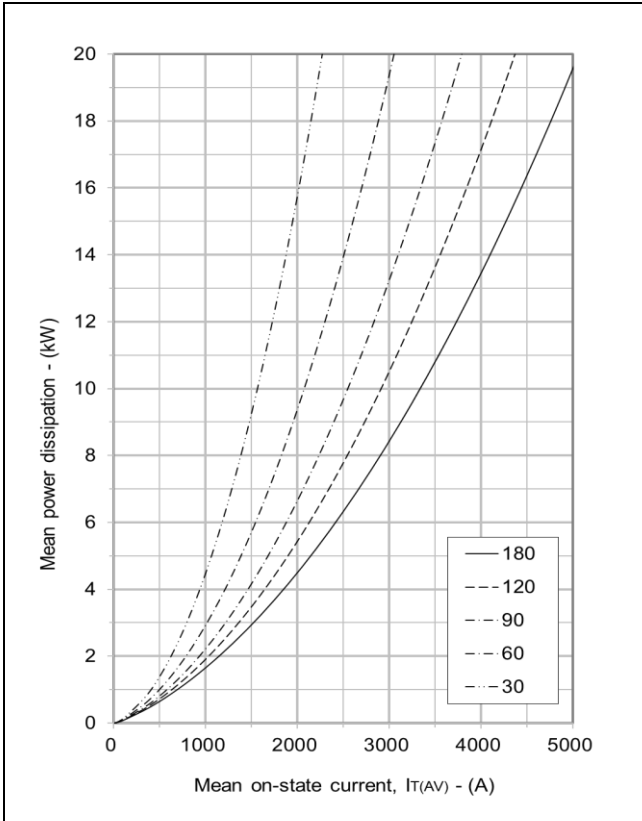


Fig. 3 On-state power dissipation - sine wave

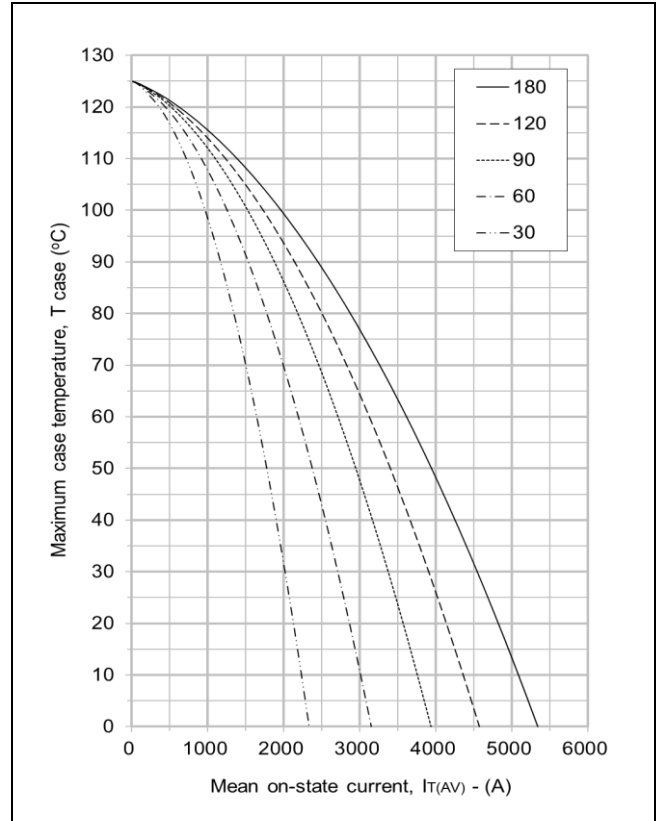


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

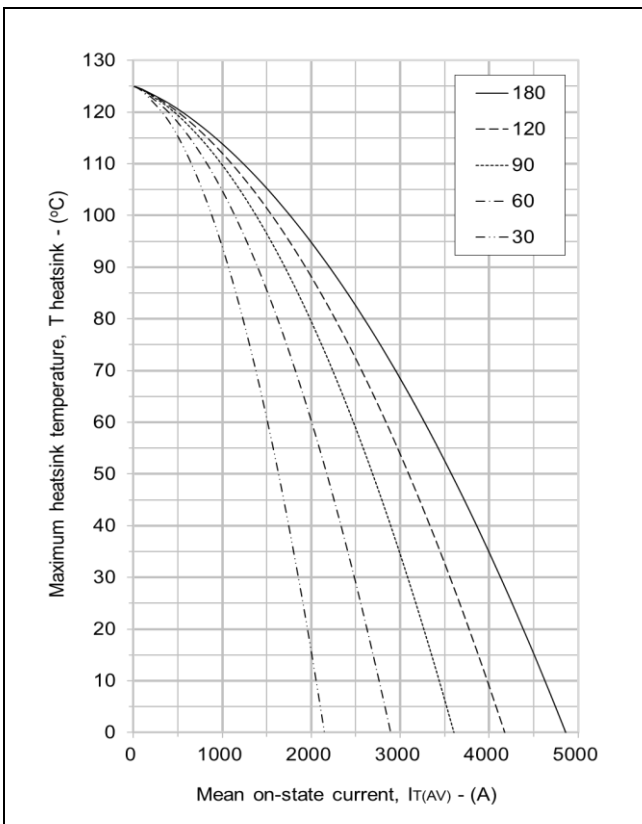


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

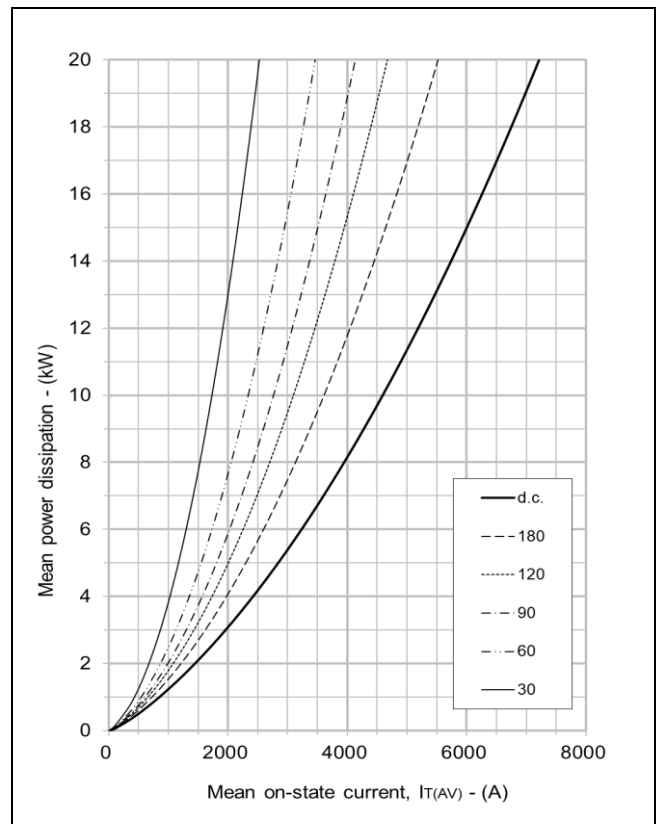


Fig. 6 On-state power dissipation - rectangular wave

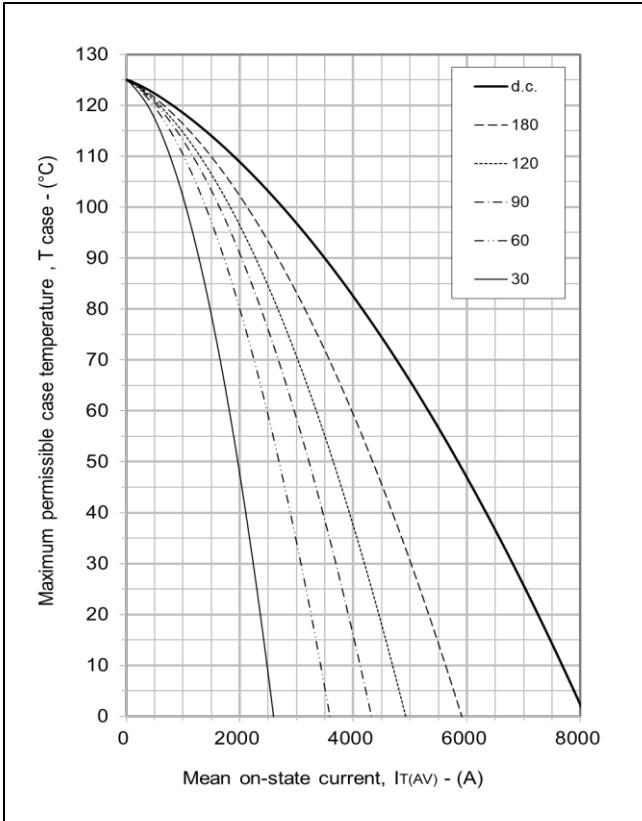


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave

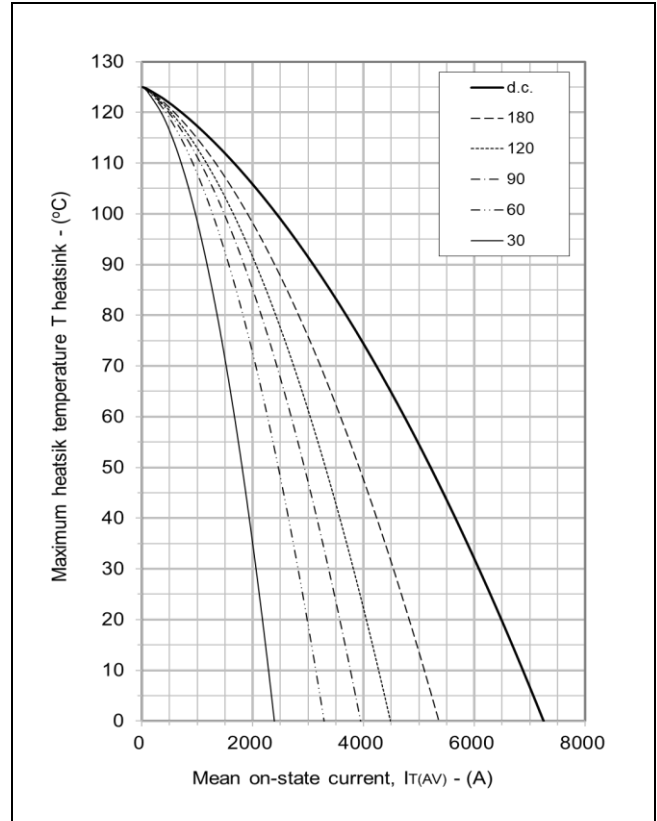


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

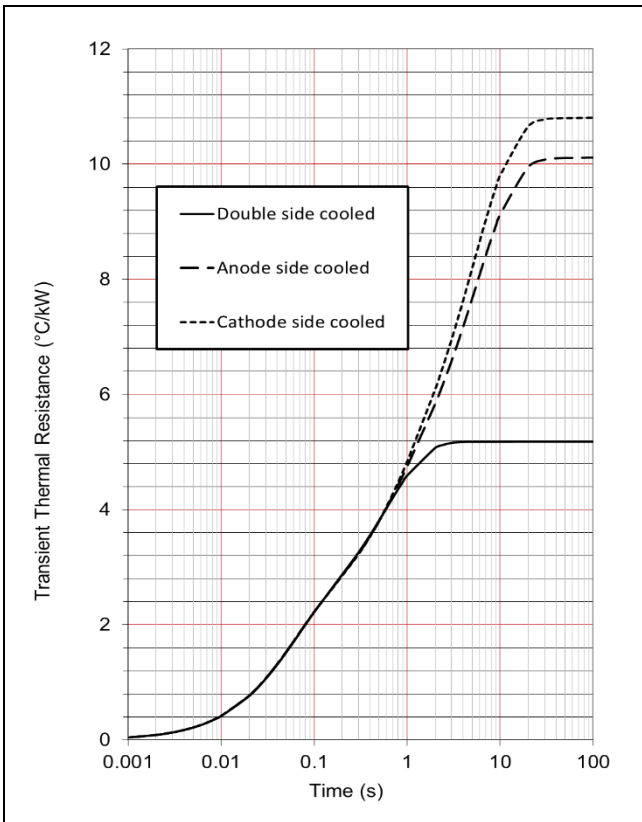


Fig.9 Maximum (limit) transient thermal impedance – junction to case (degC/kW)

		1	2	3	4
Double side cooled	Ri(°C/kW)	1.995	1.243	1.945	0.005
	Ti(s)	0.050	0.593	0.592	110.511
Anode side cooled	Ri(°C/kW)	6.093	1.957	2.042	0.036
	Ti(s)	5.460	0.511	0.050	110.174
Cathode side cooled	Ri(°C/kW)	6.857	1.876	2.063	0.025
	Ti(s)	5.181	0.557	0.050	110.155

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

$\Delta R_{th(j-c)}$  Conduction

Tables show the increments of thermal resistance  $R_{th(j-c)}$  when the device operates at conduction angles other than d.c.

Double side cooling			Anode Side Cooling			Cathode Sided Cooling		
$\theta^*$	$\Delta Z_{th} (z)$		$\theta^*$	$\Delta Z_{th} (z)$		$\theta^*$	$\Delta Z_{th} (z)$	
	sine.	rect.		sine.	rect.		sine.	rect.
180	0.51	0.36	180	0.51	0.36	180	0.51	0.36
120	0.57	0.49	120	0.58	0.50	120	0.58	0.50
90	0.64	0.56	90	0.65	0.57	90	0.65	0.57
60	0.70	0.63	60	0.71	0.64	60	0.71	0.64
30	0.74	0.71	30	0.75	0.71	30	0.75	0.71
15	0.76	0.74	15	0.77	0.75	15	0.77	0.75

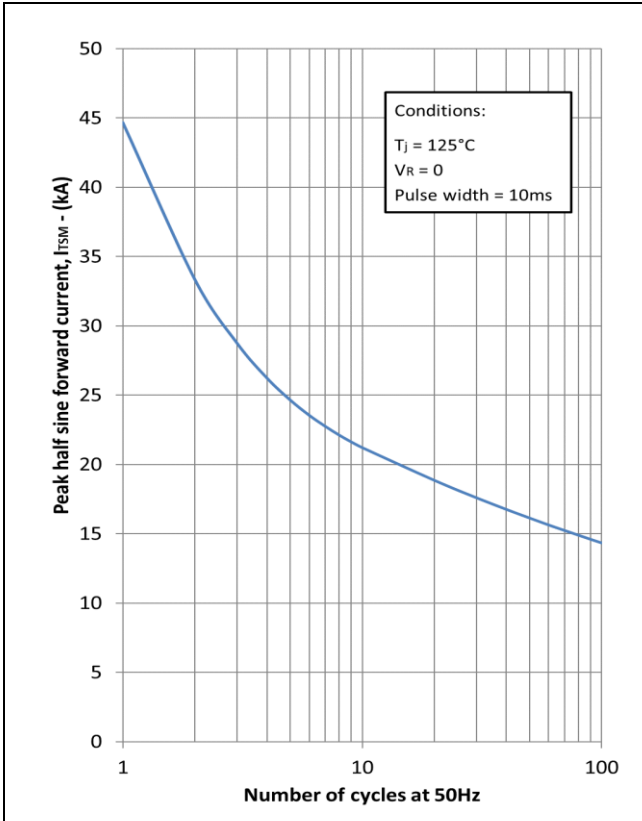


Fig. 10 Multi-cycle surge current

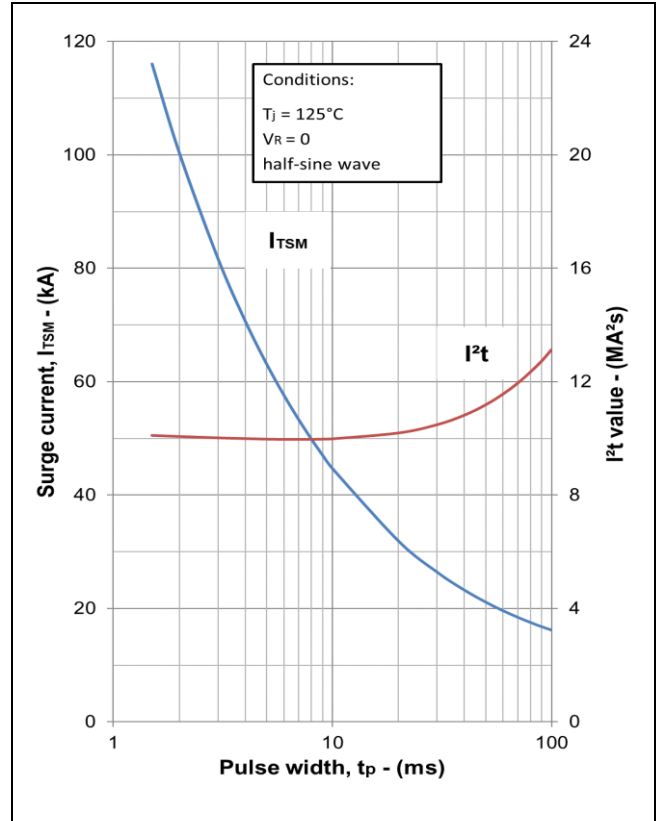


Fig. 11 Single-cycle surge current

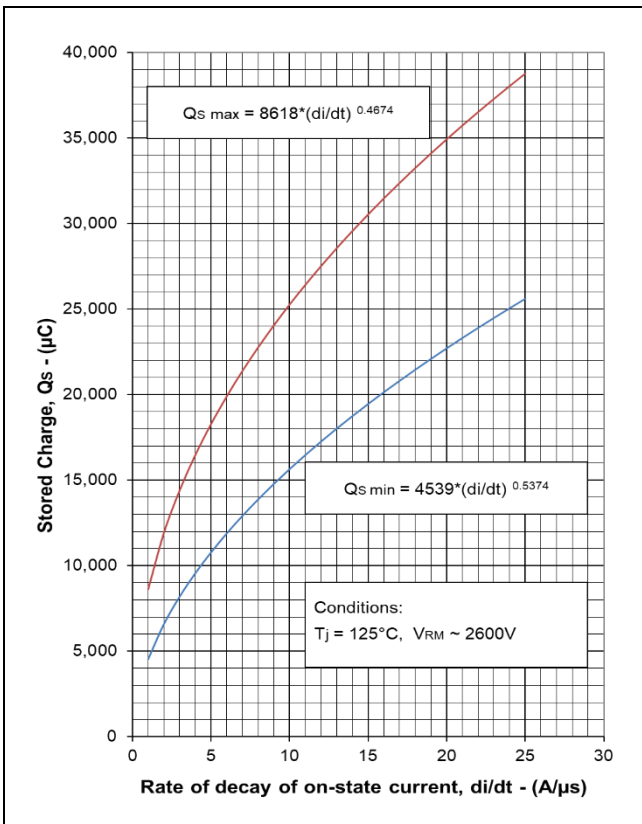


Fig. 12 Stored charge

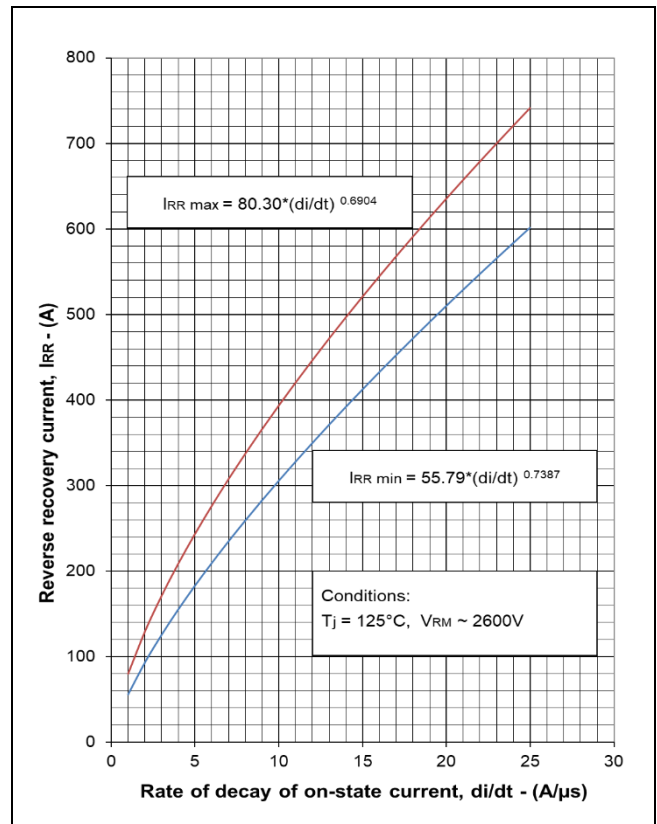


Fig. 13 Reverse recovery current

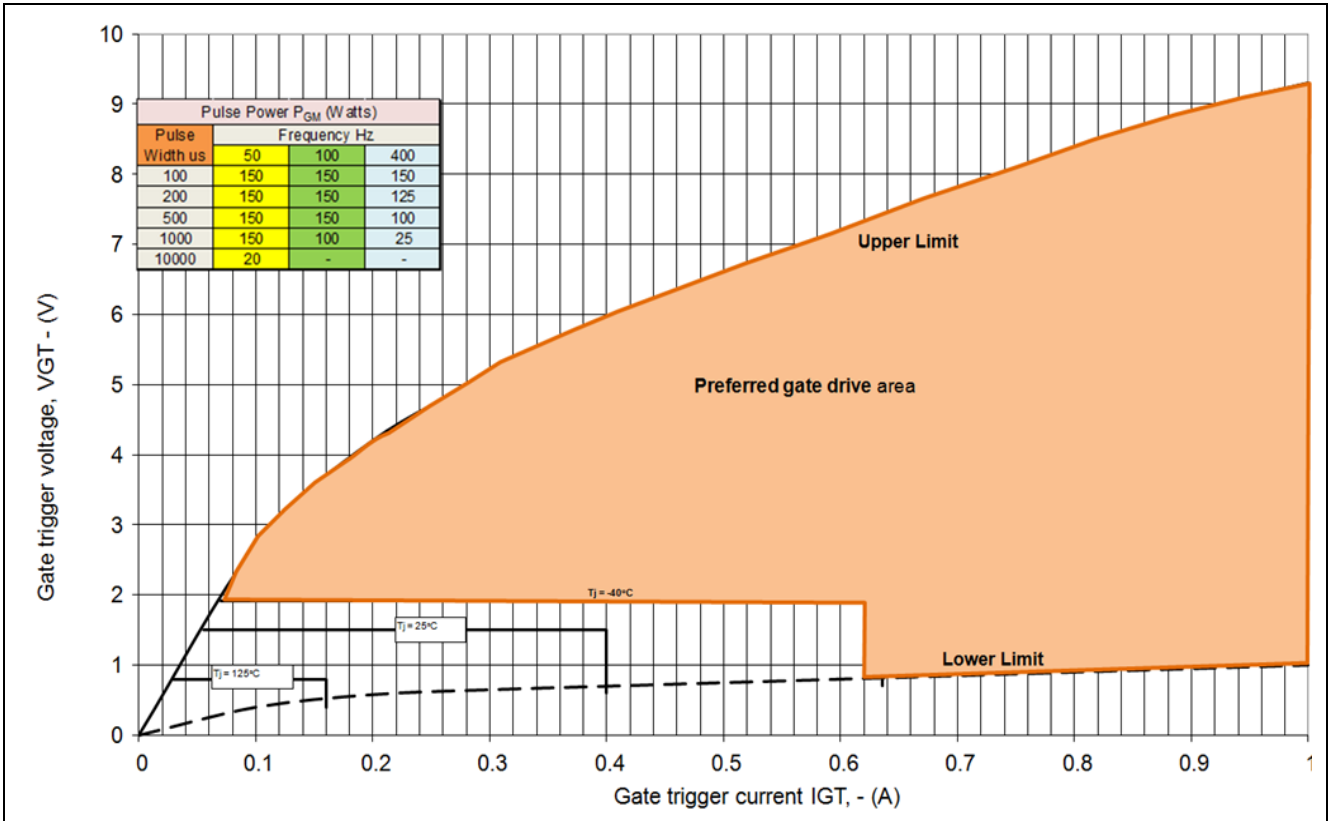


Fig.14 Gate characteristics

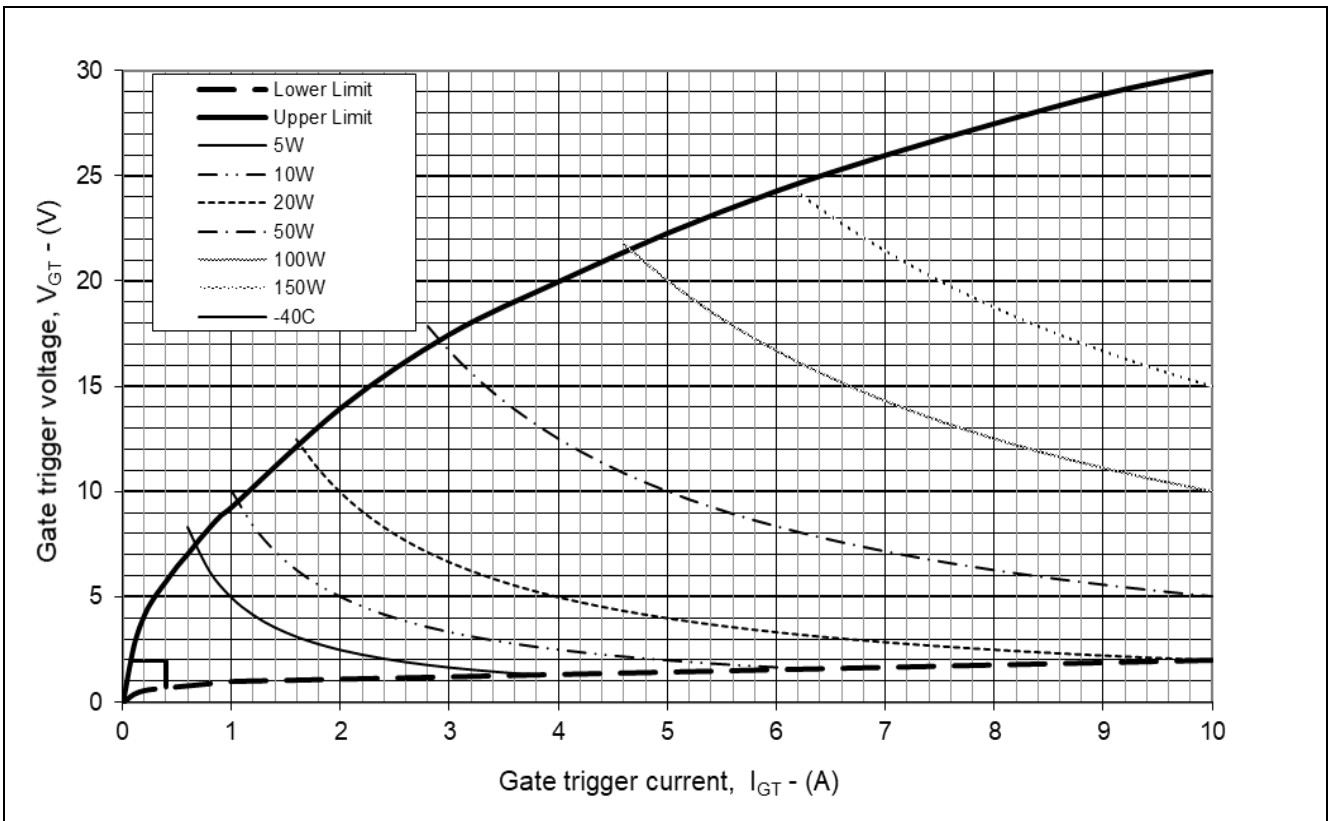


Fig. 15 Gate characteristics



**PACKAGE DETAILS**

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

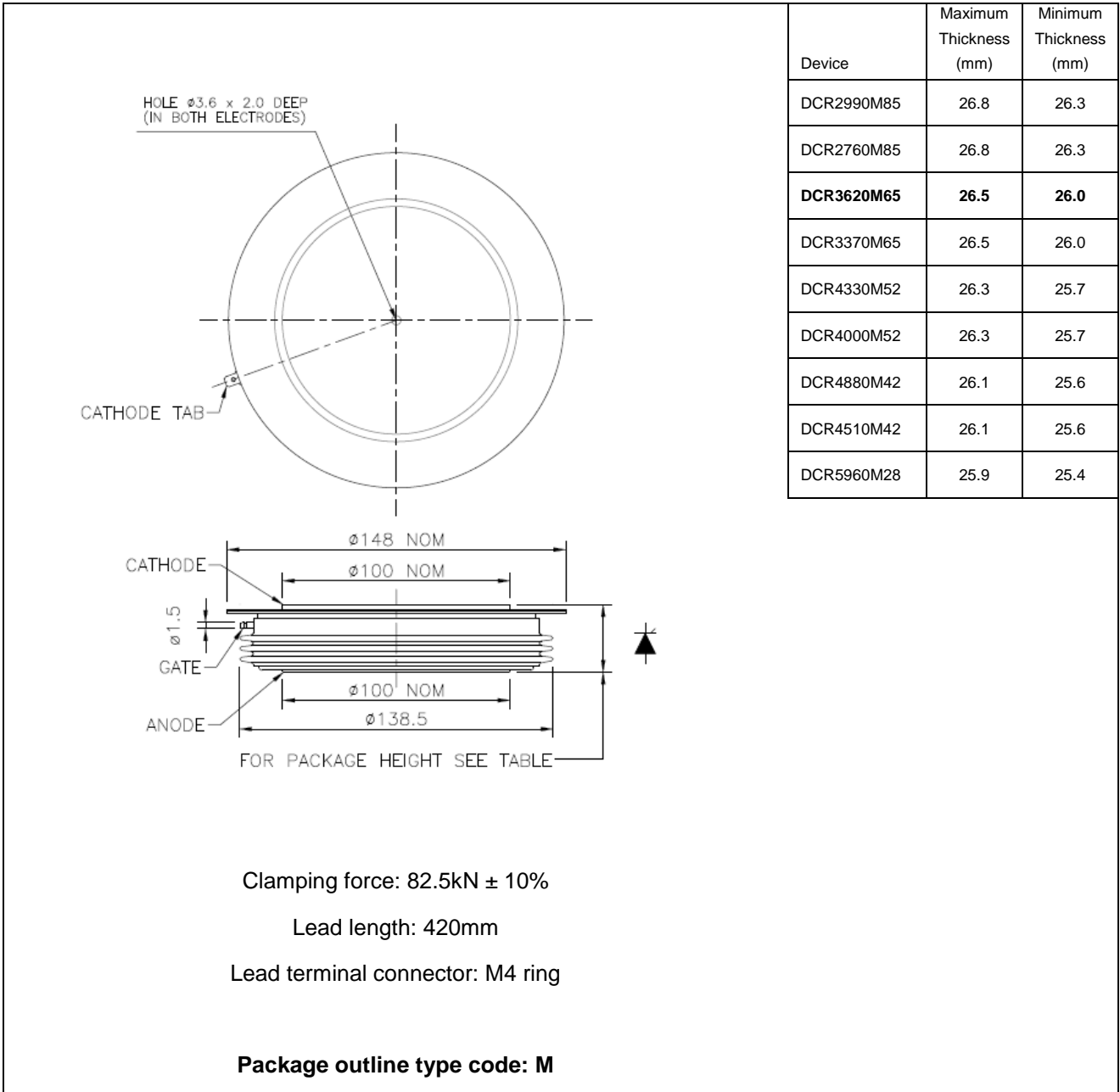


Fig. 16 Package outline

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